

# 2SB861

Silicon PNP Triple Diffused

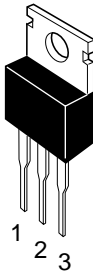
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## Application

Low frequency power amplifier color TV vertical deflection output complementary pair with 2SD1138

## Outline

TO-220AB



1. Base
2. Collector (Flange)
3. Emitter

## Absolute Maximum Ratings (Ta = 25°C)

| Item                         | Symbol        | Rating      | Unit |
|------------------------------|---------------|-------------|------|
| Collector to base voltage    | $V_{CBO}$     | -200        | V    |
| Collector to emitter voltage | $V_{CEO}$     | -150        | V    |
| Emitter to base voltage      | $V_{EBO}$     | -6          | V    |
| Collector current            | $I_C$         | -2          | A    |
| Collector peak current       | $I_{C(peak)}$ | -5          | A    |
| Collector power dissipation  | $P_C$         | 1.8         | W    |
|                              | $P_C^{*1}$    | 30          | W    |
| Junction temperature         | $T_j$         | 150         | °C   |
| Storage temperature          | $T_{stg}$     | -45 to +150 | °C   |

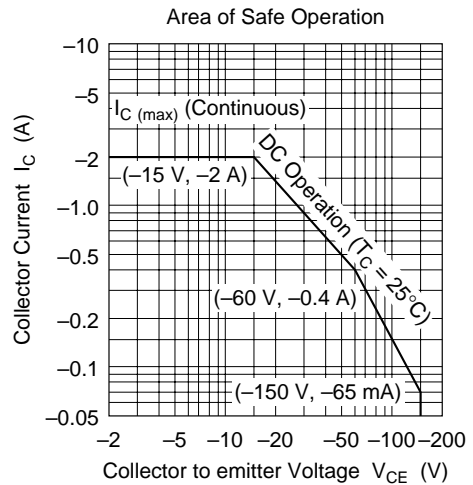
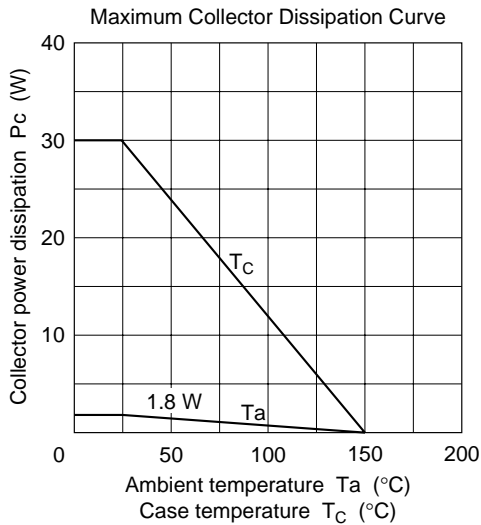
Note: 1. Value at  $T_C = 25^\circ\text{C}$

## Electrical Characteristics (Ta = 25°C)

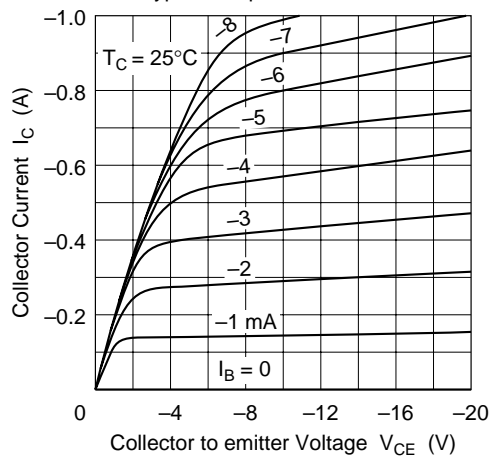
| Item                                    | Symbol         | Min  | Typ | Max | Unit          | Test conditions  |
|---|----------------|------|-----|-----|---------------|--|
| Collector to emitter breakdown voltage  | $V_{(BR)CBO}$  | -150 | —   | —   | V             | $I_C = -50 \text{ mA}$ , $R_{BE} = \infty$                     |
| Emitter to base breakdown voltage       | $V_{(BR)EBO}$  | -6   | —   | —   | V             | $I_E = -5 \text{ mA}$ , $I_C = 0$                              |
| Collector cutoff current                | $I_{CBO}$      | —    | —   | -1  | $\mu\text{A}$ | $V_{CB} = -120 \text{ V}$ , $I_E = 0$                          |
| DC current transfer ratio               | $h_{FE1}^{*1}$ | 60   | —   | 200 |               | $V_{CE} = -4 \text{ V}$ , $I_C = -50 \text{ mA}$               |
|   | $h_{FE2}$      | 60   | —   | —   |               | $V_{CE} = -10 \text{ V}$ , $I_C = -500 \text{ mA}^{*2}$        |
| Collector to emitter saturation voltage | $V_{CE(sat)}$  | —    | —   | -3  | V             | $I_C = -500 \text{ mA}$ , $I_B = -50 \text{ mA}$               |
| Base to emitter voltage                 | $V_{BE}$       | —    | —   | -1  | V             | $V_{CE} = -4 \text{ V}$ , $I_C = -50 \text{ mA}$               |
| Collector output capacitance            | $C_{ob}$       | —    | 30  | —   | pF            | $V_{CB} = -100 \text{ V}$ , $I_E = 0$ ,<br>$f = 1 \text{ MHz}$ |

- Notes: 1. The 2SB861 is grouped by  $h_{FE1}$  as follows.  
2. Pulse test

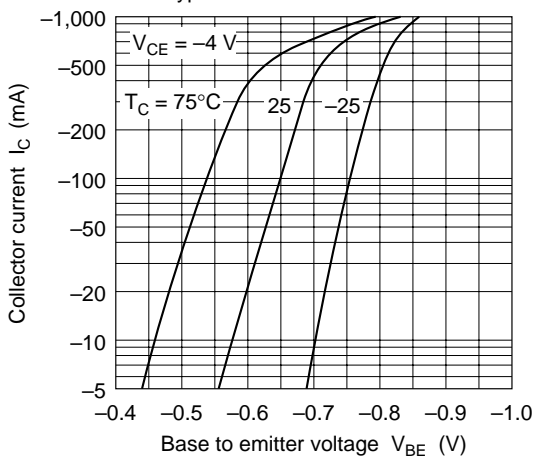
| B         | C          |
|-----------|------------|
| 60 to 120 | 100 to 200 |



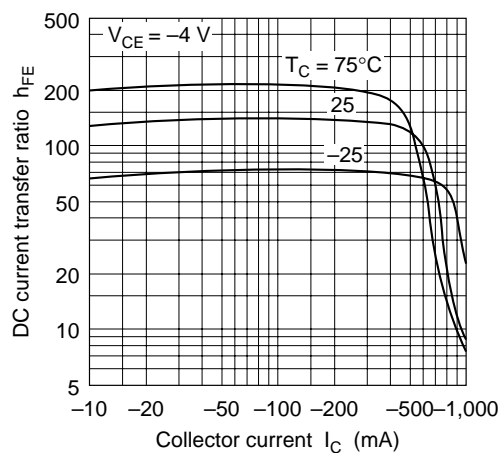
Typical Output Characteristics



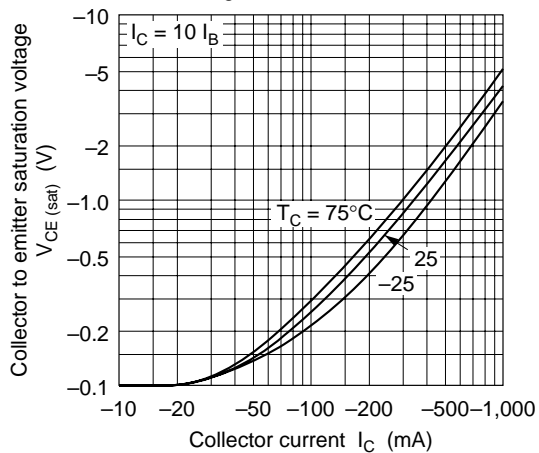
Typical Transfer Characteristics

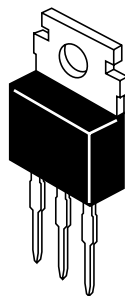
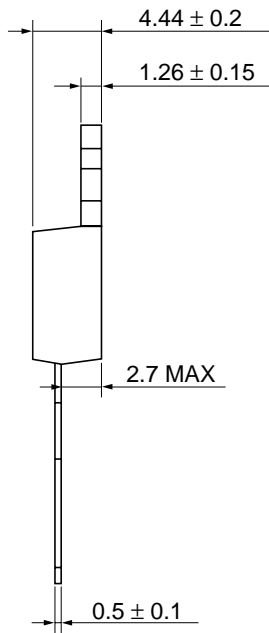
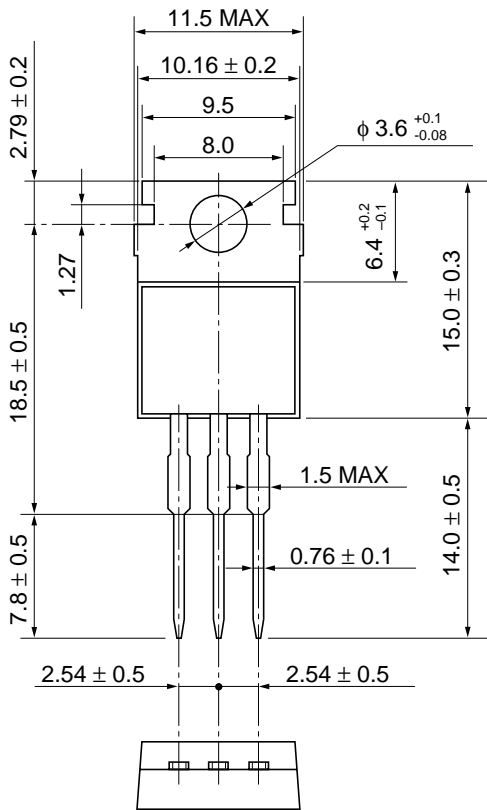


DC Current Transfer Ratio vs. Collector Current



Collector to Emitter Saturation Voltage vs. Collector Current





|                          |          |
|--------------------------|----------|
| Hitachi Code             | TO-220AB |
| JEDEC                    | Conforms |
| EIAJ                     | Conforms |
| Weight (reference value) | 1.8 g    |

## Cautions

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